## MAX22344-MAX22346 Evaluation Kits

### **General Description**

The MAX22344–MAX22346 evaluation kits (EV kits) provide a proven design to evaluate the MAX22344–MAX22346, reinforced, four-channel, galvanic digital isolators. Two types of evaluation boards are available to support different channel direction configurations and different ENA polarities of the MAX22344–MAX22346 family. The MAX22345CSEVKIT# is fully assembled and tested, and comes populated with the MAX22345CAAP+(Figure 1). The MAX2234XSEVKIT# is a generic board which has U1 unpopulated allowing the user to select a device from the MAX22344-MAX22346 family (Figure 2). Both evaluation boards support the 20-pin SSOP package type. See Table 1 for EV kit options.

The EV kits should be powered from two independent isolated power supplies with nominal output voltage in range from 1.71V to 5.5V. For evaluating the electrical parameters of the device without any isolation between the two sides, a single power supply can also be used.

The MAX2234XSEVKIT# comes with U1 unpopulated and supports the following digital isolators: MAX22344BAAP+, MAX22344CAAP+, MAX22345BAAP+, MAX22345CAAP+, MAX22345RAAP+, MAX22346BAAP+, MAX22346CAAP+.

**Note**: When ordering the MAX2234XS EV kit, the engineer should request a sample of the desired MAX22344-MAX22346 isolator IC that can be soldered to the PCB.

#### **Features**

 Broad Range of Data Transfer Rates (from DC to 200Mbps)

Evaluates: MAX22344-MAX22346

- Four Unidirectional Channels with 3 Different Channel Direction Configurations
- SMA Connectors for Easy Connection to External Equipment
- Wide Power Supply Voltage Range from 1.71V to 5.5V
- Guaranteed Up to 3.75kV<sub>RMS</sub> Isolation for 60s
- -40°C to +125°C Temperature Range
- Proven PCB Layout

Ordering Information appears at end of data sheet.

**Table 1. EV Kit Options** 

EVKIT PART#	TARGET DEVICE	PACKAGE TYPE	COMMENT
MAX22345CSEVKIT#	MAX22345CAAP+	20-Pin SSOP	200Mbps IC Populated
MAX2234XSEVKIT#	Not Populated	20-Pin SSOP	Request Samples of Target Device from Maxim



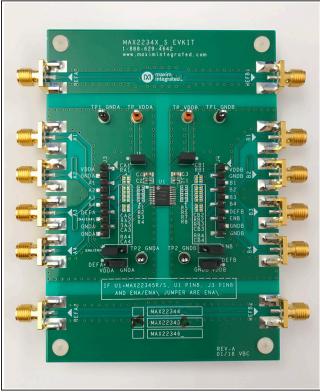


Figure 1. MAX22345CS EV KIT

## **Quick Start**

### **Required Equipment**

- MAX22345CS, or MAX2234XS EV kit
- MAX22344–MAX22346 device, if EV kit is not populated
- Two DC power supplies with output range of 1.71V to 5.5V
- Signal/function generator
- Oscilloscope

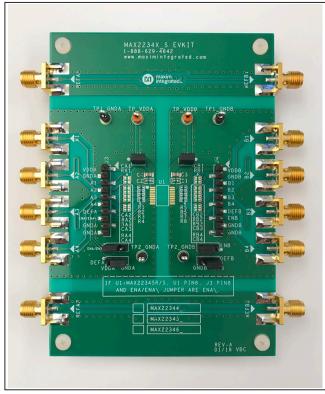


Figure 2. MAX2234XS EV KIT

### **Procedure**

The MAX22345CS EV kit is fully assembled and ready for evaluation. The MAX2234XS EV kit has everything except the DUT (U1) installed. The user can install the desired version of the MAX22344–MAX22346 family of reinforced, four-channel, unidirectional digital isolators. Once installed, follow the steps below to verify board functionality:

## MAX22344-MAX22346 Evaluation Kits

- Evaluates: MAX22344-MAX22346
- 1) Verify jumper settings. See <u>Table 2</u> for all shunt positions.
  - J1 and J2 are closed.
  - Jumper ENA is either in 1-2 position if U1 ENA (pin 8) has active-high polarity, or in 2-3 position if U1 ENA (pin 8) has active-low polarity.
  - Jumper ENB is in 1-2 position.
  - Jumper DEFA and DEFB are in 2-3 position.
- Connect one DC power supply between the EV kit's TP\_VDDA and TP1\_GNDA test points; connect the other DC power supply between TP\_VDDB and TP1\_ GNDB test points.
- 3) Set both DC power supply outputs between 1.71V and 5.5V, and then enable the power supply output.

**Note:** It is also possible to power the EV kits from a single power supply to test electrical parameters but this invalidates the digital isolation of the IC.

4) Connect the signal/function generator to an input SMA connector or test point of side A and observe the isolated signal on the corresponding side B output, using an oscilloscope. On the MAX22345CS EV kit, SMA connectors A1, A2, A3, and B4 are inputs, and SMA connectors B1, B2, B3, and A4 are outputs. Refer to Table 3 for the SMA connector I/O configurations and jumper ENA configuration when a different MAX22344–MAX22346 device is installed as U1 on the MAX2234XS EV kit.

Table 2. MAX2234XS EV Kits Board Connectors and Shunt Positions

CONNECTOR	SHUNT POSITION	DESCRIPTION				
SIDE A						
	1	Test point or input header for V <sub>DDA</sub>				
	2	Test point or input header for GNDA				
	3	Test point or input header for I/O; same as A1 SMA				
	4	Test point or input header for I/O; same as A2 SMA				
J3	5	Test point or input header for I/O; same as A3 SMA				
J3	6	Test point or input header for I/O; same as A4 SMA				
	7	Test point or input header for side A default control; same as DEFA jumper pin 2				
	8	Test point or input header for side A enable; same as ENA jumper pin 2				
	9	Test point or input header for GNDA				
	10	Test point or input header for GNDA				
A1 (SMA)	n/a	I/O on side A				
A2 (SMA)	n/a	I/O on side A				
A3 (SMA)	n/a	I/O on side A				
A4 (SMA)	n/a	I/O on side A				
J1	Open	Use current meter to measure current of side A				
JI	1-2*	Connect power supply to V <sub>DDA</sub>				
DEEA	1-2	Connect side A default control pin to $V_{\text{DDA}}$ ; side A output default is set to high. Jumper DEFA must be set in the same position as DEFB				
DEFA	2-3*	Connect side A default control pin to GNDA; side A output default is set to low. Jumper DEFA must be set in the same position as DEFB. Default setting on MAX22345CSEVKIT#				
ENA	1-2*	Connect side A enable pin to $V_{DDA}$ ; side A outputs are enabled if ENA is active-high (MAX2234_B/C), or high-impedance if active-low (MAX22345R/S). Default setting on MAX22345CSEVKIT#				
	2-3	Connect side A enable pin to GNDA; side A outputs are high-impedance if ENA is active-high (MAX2234_B/C), or enabled if active-low (MAX22345R/S)				
	Open	Side A enable pin not connected; default setting on MAX2234XSEVKIT#				

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Table 2. MAX2234XS EV Kits Board Connectors and Shunt Positions (continued)

CONNECTOR	SHUNT POSITION	DESCRIPTION				
SIDE B						
	1	Test point or input header for V <sub>DDB</sub>				
	2	Test point or input header for GNDB				
	3	Test point or input header for I/O; same as B1 SMA				
	4	Test point or input header for I/O; same as B2 SMA				
J4	5	Test point or input header for I/O; same as B3 SMA				
J4	6	Test point or input header for I/O; same as B4 SMA				
	7	Test point or input header for side B default control; same as DEFB jumper pin 2				
	8	Test point or input header for side B enable; same as ENB jumper pin 2				
	9	Test point or input header for GNDB				
	10	Test point or input header for GNDB				
B1 (SMA)	n/a	I/O on side B				
B2 (SMA)	n/a	I/O on side B				
B3 (SMA) n/a		I/O on side B				
B4 (SMA) n/a		I/O on side B				
J2	Open	Use current meter to measure current of side B				
JZ	1-2*	Connect power supply to V <sub>DDB</sub>				
DEED	1-2	Connect side B default control pin to $V_{\mbox{\scriptsize DDB}}$ ; side B output default is set to high. Jumper DEFB must be set in the same position as DEFA				
DEFB	2-3*	Connect side B default control pin to GNDB; side B output default is set to low. Jumper DEFB must be set in the same position as DEFA. Default setting on MAX22345CSEVKIT#				
ENB	1-2*	Connect side B enable pin to $V_{DDB}$ ; side B outputs are enabled. Default setting on MAX22345CSEVKIT#				
	2-3	Connect side B enable pin to GNDB; side B outputs are high-impedance				

<sup>\*</sup>Default configuration

**Table 3. MAX2234XS EV Kits Connector Configurations** 

CONNECTOR	U1 DEVICE					
CONNECTOR	MAX22344B/C	MAX22345B/C	MAX22345R/S	MAX22346B/C		
SIDE A						
A1 (SMA)	IN1	IN1	IN1	IN1		
A2 (SMA)	IN2	IN2	IN2	IN2		
A3 (SMA)	IN3	IN3	IN3	OUT3		
A4 (SMA)	IN4	OUT4	OUT4	OUT4		
J3 PIN 8, ENA PIN 2	ENA	ENA	ENA	ENA		
SIDE B						
B1 (SMA)	OUT1	OUT1	OUT1	OUT1		
B2 (SMA)	OUT2	OUT2	OUT2	OUT2		
B3 (SMA)	OUT3	OUT3	OUT3	IN3		
B4 (SMA)	OUT4	IN4	IN4	IN4		
J4 PIN 8, ENB PIN 2	ENB	ENB	ENB	ENB		

## **Detailed Description of Hardware**

The MAX22344–MAX22346 EV kits allow the user to evaluate the features of the MAX22344–MAX22346 four-channel digital isolators.

### **External Power Supplies**

Power to the MAX22345CS and MAX2234XS EV kits is derived from two external sources which can both be between  $\pm 1.71V$  and  $\pm 5.5V$ . Connect one source between the  $V_{DDA}$ 

and GNDA test points, and the other source between the  $V_{DDB}$  and GNDB test points. Each supply can be set independently and can be present over the entire range from +1.71V to +5.5V, regardless of the level or presence of the other supply. The MAX22344–MAX22346 level-shift the data, transmitting them across the isolation barrier.

Four SMA connectors on each side of the board allow easy connections to signal generator(s) and oscilloscope. A typical test setup is shown in Figure 3.

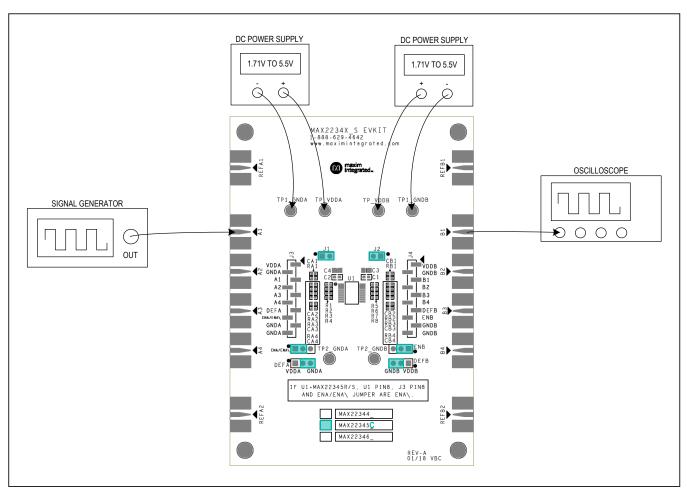


Figure 3. MAX2234XS EV Kit Typical Test Setup

#### **Decoupling Capacitors**

Each power supply is decoupled with a  $1\mu F$  ceramic capacitor in parallel with a  $0.1\mu F$  ceramic capacitor, which are placed close to the U1  $V_{DDA}$  and  $V_{DDB}$  pin.

#### **Shunt Positions**

Jumpers J1 and J2 are installed between the external power supplies and U1 power supply pins to allow supply current measurement. Uninstall the J1 and J2 shunts and connect current meters on both side A and side B to measure the MAX22344–MAX22346 supply current.

Jumper ENA and ENB are provided to enable or disable the outputs of the MAX22344–MAX22346 isolator channels. To enable devices with an active-high enable pin (ENA) on side A (MAX2234\_B/C), connect the ENA shunt to  $V_{\mbox{\scriptsize DDA}}$ . To enable devices with an active-low enable pin (ENA) on side A (MAX22345R/S), connect the ENA shunt to GNDA. Side A outputs are high-impedance when disabled. Connect the ENB shunt to  $V_{\mbox{\scriptsize DDB}}$  to enable side B channels or connect to GNDB to disable side B channels. Side B outputs are high-impedance when disabled.

The MAX22344–MAX22346 feature user-selectable default-high or default-low outputs. To configure the default level of both side A and side B outputs to high, connect the DEFA shunt to  $V_{DDA}$  and the DEFB shunt to  $V_{DDB}$ . To configure the default level of the outputs to low, connect the DEFA shunt to GNDA and the DEFB shunt to GNDB. Ensure the logic state of DEFA is the same as that for DEFB. Configure DEFA and DEFB before powering up the board and do not toggle DEFA and DEFB during normal operation. See <u>Table 2</u> for all shunt positions and Table 3 for connector configurations.

#### I/O Traces Impedance Control

The input and output traces of all four isolation channels have an impedance control of  $50\Omega$ . A  $20\Omega$  series resistor is added to all input and output channels; along with the internal series resistance, it can provide  $50\Omega$  impedance matching with external equipment such as function generators or oscilloscopes.

#### **Output Load**

Each output has an unpopulated 0603 SMT resistor (RA1–RA4, RB1–RB4) and an unpopulated 0603 SMT capacitor (CA1–CA4, CB1–CB4) to GND\_ to allow different loads based on customer requirements.

#### **Calibration Channels**

Two reference channels (REFA1–REFB1, REFA2–REFB2) are implemented on the EV kits to help calibrate the test setup for timing measurements such as propagation delay. Measure the propagation delay (tpD\_REF) using the reference channel first to determine the delay introduced by the test setup. Measure the propagation delay (tpD\_ISO) again using one of the MAX22344–MAX22346 data channels. The calibrated isolator delay is tpD\_ISO - tpD\_REF.

#### U1 on the MAX2234XS EV Kit

U1 on the MAX2234XSEVKIT# is not installed. The user can install the desired version of the MAX22344-MAX22346 family of four-channel unidirectional digital isolators. The MAX22344-MAX22346 family offers three unidirectional channel configurations. The MAX22344 features all four channels transferring digital signals in one direction. SMA connectors A1-A4 on side A are input connectors and B1-B4 on side B are output connectors if the MAX22344 is installed as U1. The MAX22345 has three channels transmitting data in one direction and one channel transmitting in the opposite direction. SMA connectors A1-A3 and B4 are input connectors and B1-B3 and A4 are output connectors if the MAX22345 is installed as U1. The MAX22346 provides two channels in each direction. SMA connectors A1, A2, B3, and B4 are input connectors and B1, B2, A3 and A4 are output connectors if the MAX22346 is installed as U1. Refer to Table 3 for SMA connector I/O configurations with different U1 selection.

When installing U1, make sure pin 1 of the device is mounted onto pin 1 of U1 on the PCB. Pin 1 is located at the upper-left corner of U1, denoted by a white dot on the silkscreen.

## **Ordering Information**

PART	TYPE		
MAX22345CSEVKIT#*	EV Kit with installed MAX22345CAAP+		
MAX2234XSEVKIT#	EV Kit for 20-pin SSOP package		

<sup>#</sup>Denotes RoHS compliant.

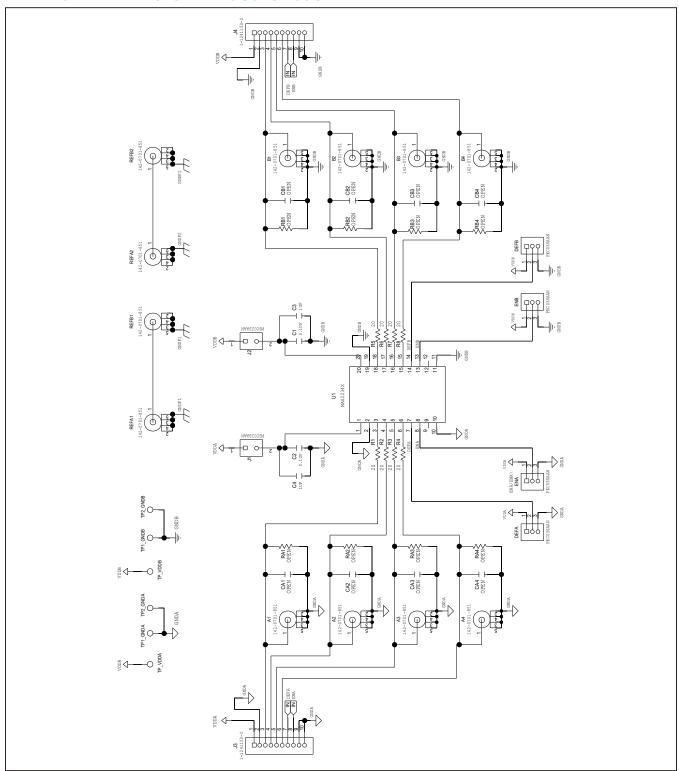
<sup>\*</sup>Future product—contact factory for availability.

## MAX22344-MAX22346 EV Kit Bill of Materials

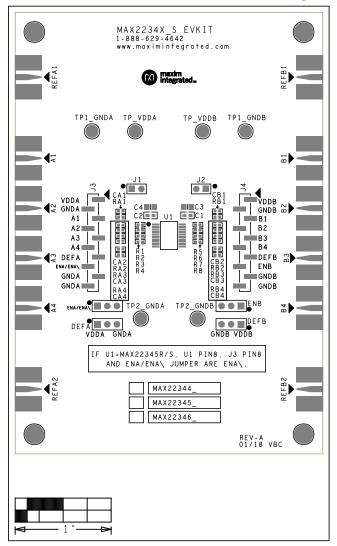
ITEM	REF_DES		QTY	MFG PART#	MANUFACTURER	VALUE	DESCRIPTION	COMMENTS
1	A1-A4, B1-B4, REFA1, REFA2, REFB1, REFB2		12	142-0701-851	JOHNSON COMPONENTS	142-0701-851	CONNECTOR; END LAUNCH JACK RECEPTACLE; BOARDMOUNT; STRAIGHT THROUGH; 2PINS;	
2	C1, C2		2	GCJ188R71H104KA12; GCM188R71H104K; CGA3E2X7R1H104K080AA	MURATA;MURATA;TDK	0.1µF	CAPACITOR; SMT (0603); CERAMIC CHIP; 0.1µF; 50V; TOL=10%; TG=-55°C TO +125°C; TC=X7R; AUTO	
3	C3, C4		2	GRM21BR71H105KA12; CL21B105KBFNNNE; C2012X7R1H105K085AC; UMK212B7105KG	MURATA;SAMSUNG ELECTRONICS;TDK;TAIYO YUDEN	1μF	CAPACITOR; SMT (0805); CERAMIC CHIP; 1µF; 50V; TOL=10%; TG=-55°C TO +125°C; TC=X7R	
4	ENA, ENB, DEFA, DEFB		4	PEC03SAAN	SULLINS	PEC03SAAN	CONNECTOR; MALE; THROUGH HOLE; BREAKAWAY; STRAIGHT; 3PINS	
5	J1, J2		2	PEC02SAAN	SULLINS	PEC02SAAN	CONNECTOR; MALE; THROUGH HOLE; BREAKAWAY; STRAIGHT; 2PINS	
6	J3, J4		2	1-1241150-0	TE CONNECTIVITY	1-1241150-0	CONNECTOR; MALE; SMT; AMPMODU II PIN HEADER; SINGLE ROW; PACKED IN BLISTER; STRAIGHT; 10PINS	
7	R1-R8		8	CRCW040220R0FK	VISHAY DALE	20	RESISTOR; 0402; 20 OHM; 1%; 100PPM; 0.063W; THICK FILM	
8	SU1-SU6		6	STC02SYAN	SULLINS ELECTRONICS CORP.	STC02SYAN	TEST POINT; JUMPER; STR; TOTAL LENGTH=0.256IN; BLACK; INSULATION=PBT CONTACT=PHOSPHOR BRONZE; COPPER PLATED TIN OVERALL	
9	TP1_GNDA, TP1_GNDB, TP2_GNDA, TP2_GNDB		4	5011	KEYSTONE	N/A	TEST POINT; PIN DIA=0.125IN; TOTAL LENGTH=0.445IN; BOARD HOLE=0.063IN; BLACK; PHOSPHOR BRONZE WIRE SILVER PLATE FINISH;	
10	TP_VDDA, TP_VDDB		2	5013	KEYSTONE	N/A	TEST POINT; PIN DIA=0.125IN; TOTAL LENGTH=0.445IN; BOARD HOLE=0.063IN; ORANGE; PHOSPHOR BRONZE WIRE SILVER PLATE FINISH;	
11	U1		1	MAX2234X	MAXIM	MAX2234X	EVKIT PART - IC; MAX2234X SERIES; PACKAGE DRAWING NUMBER: 21-0056; PACKAGE LAND PATTERN: 90-0094; PACKAGE CODE: A20MS+6; SSOP20	
12	PCB		1	MAX2234XS	MAXIM	PCB	PCB:MAX2234XS	=
13	MTH1-MTH4	DNI	4	1902B	GENERIC PART	N/A	STANDOFF; FEMALE-THREADED; HEX; 4-40IN; 3/8IN; NYLON	
14	MTH1-MTH4	DNI	4	P440.375	GENERIC PART	N/A	MACHINE SCREW; SLOTTED; PAN; 4- 40IN; 3/8IN; NYLON	
15	RA1-RA4, RB1-RB4	DNP	0	N/A	N/A	OPEN	PACKAGE OUTLINE 0402 RESISTOR	
16	CA1-CA4, CB1-CB4	DNP		N/A	N/A	OPEN	PACKAGE OUTLINE 0402 NON-POLAR CAPACITOR	
TOTAL			54					

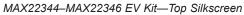
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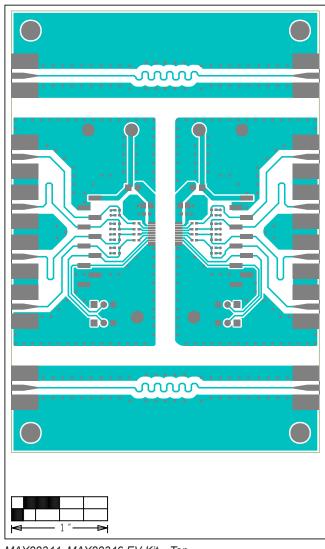
## MAX22344-MAX22346 EV Kit Schematic



# MAX22344-MAX22346 EV Kit PCB Layout Diagrams

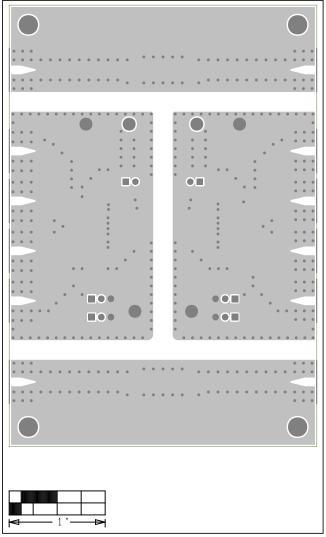


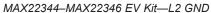


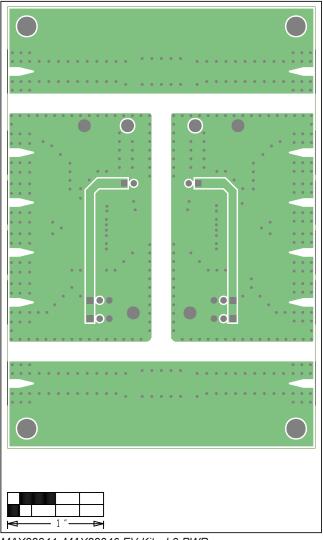


MAX22344-MAX22346 EV Kit-Top

# MAX22344-MAX22346 EV Kit PCB Layout Diagrams (continued)

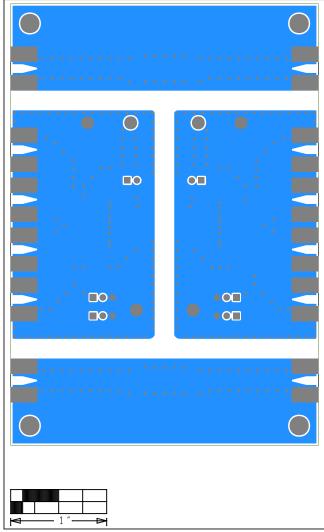






MAX22344-MAX22346 EV Kit-L3 PWR

# MAX22344-MAX22346 EV Kit PCB Layout Diagrams (continued)



MAX22344-MAX22346 EV Kit-Bottom